

Product Bulletin

Document # : PB22768X Issue Date: 9 July 2019

Title of Change:	Notification of marking update in production material.	
Effective date:	9 July 2019	
Contact information:	Contact your local ON Semiconductor Sales Office or < <u>GuoKun.Yeng@onsemi.com</u> >	
Type of notification:	This Product Bulletin is for notification purposes only. ON Semiconductor will proceed with implementation of this change upon publication of this Product Bulletin.	
Change Category:	Wafer Fab Assembly Change	☐ Test Change
Change Sub-Category(s): Manufacturing Site Addition Manufacturing Site Transfer Manufacturing Process Change	Material Change Product specific change	□ Datasheet/Product Doc change□ Shipping/Packaging/Marking✓ Other:Marking
Sites Affected:	ON Semiconductor Sites: ON Seremban, Malaysia	External Foundry/Subcon Sites: Amkor Malaysia
Description and Purpose:		
This Product Bulletin is to announce, ON Semiconductor is updating Line 1 marking for orderable part, NTMFS4C020NT1G. This purpose of this update is to correct the physical marking on the units to match with datasheet marking.		
There will be no change in BOM, assembly and final testing of the device.		
The change will not impact form, fit, or function of product(s)"		
Datasheet Line 1 Marking: 4C020N Existing Line 1 Marking: 4C020 Updated Line 1Marking: 4C020N (effective date code 1925)		
List of Affected Part:		
Note : Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the PCN Customized Portal .		
NTMFS4C020NT1G		

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